

DOE

Amendment to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application.

Listing of Claims:

Claim 1 (cancelled)

Claim 2 (cancelled)

Claim 3 (cancelled)

Claim 4 (cancelled)

Claim 5 (cancelled)

Claim 6 (cancelled)

Claim 7 (cancelled)

Claim 8 (cancelled)

Claim 9 (cancelled)

Claim 10 (currently amended) An apparatus for making an embossed blister formed from a laminated film comprising:

- (a) a pin having a body and face portion, said face having an indicia thereon and said pin body being structured [adapted] to progressively engage the film from the pin face and comprising at least two contiguous frusto-conical portions having different apex angles, said pin face comprising a slightly concave surface having a peripheral edge;
- (b) a platen bearing an indicia forming die therein and structured [adapted] to accommodate a laminated film thereon wherein said platen is in a base which is not configured to form a mold against which the laminated film is contoured; and
- (c) means for advancing said pin towards and in engagement with said platen;

wherein said pin indicia and platen indicia are complementary and said pin is positioned transversally to said platen and structured [adapted] to controllably stretch said film located at the base of said blister.

Claim 11 (cancelled)

Claim 12 (currently amended) The apparatus according to claim [4-] 10 wherein the portion of the pin body adjacent to the pin face comprise different materials having differing friction parameters.

Claim 13 (cancelled)